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(12) **United States Design Patent**
Hlas et al.

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(54) **HEADPHONE**

D321,881 S * 11/1991 Hopewell D14/192
D443,261 S * 6/2001 Yuyama D14/223

(75) Inventors: **Kevin Hlas**, Portland, OR (US);
Dominic Amae, Vancouver, WA (US);
Raymond Weikel, Camas, WA (US);
Robert Jacobson, Camas, WA (US);
Steven Jensen, Vancouver, WA (US);
Omer Kotzer, Portland, OR (US);
Jamian Cobbett, Portland, OR (US);
Aaron David Hayes, Portland, OR (US)

* cited by examiner

Primary Examiner—Paula A. Mortimer
(74) *Attorney, Agent, or Firm*—Ipsolon LLP

(73) Assignee: **Logitech Europe S.A.**,
Romanel-sur-Morges (CH)

(**) Term: **14 Years**

(21) Appl. No.: **29/161,925**

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(51) **LOC (7) Cl.** **14-01**

(52) **U.S. Cl.** **D14/223; D14/205**

(58) **Field of Search** D14/188, 192,
D14/205, 206, 223, 225, 226, 227, 228,
229; 181/129, 130; 379/430, 433; 381/370,
376, 377, 381

(56) **References Cited**

U.S. PATENT DOCUMENTS

D174,053 S * 2/1955 Norris D14/192

(57) **CLAIM**

The ornamental design for a headphone, as shown and described.

DESCRIPTION

FIG. 1A is a front perspective view of a headphone showing our new design;

FIG. 1B is a back perspective view thereof;

FIG. 2 is a front elevation view thereof;

FIG. 3 is a left side elevational view thereof;

FIG. 4 is a right side elevational view thereof;

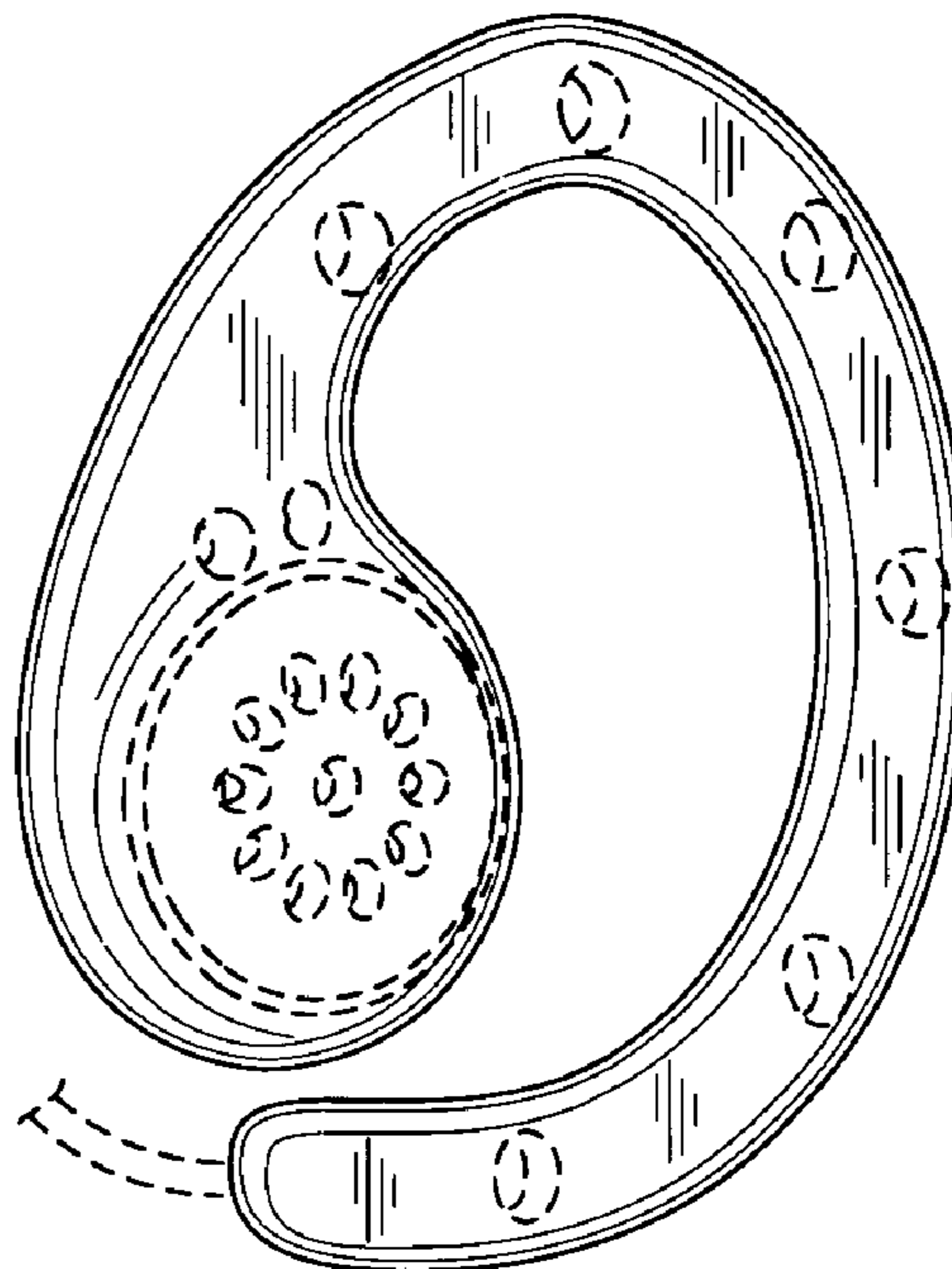
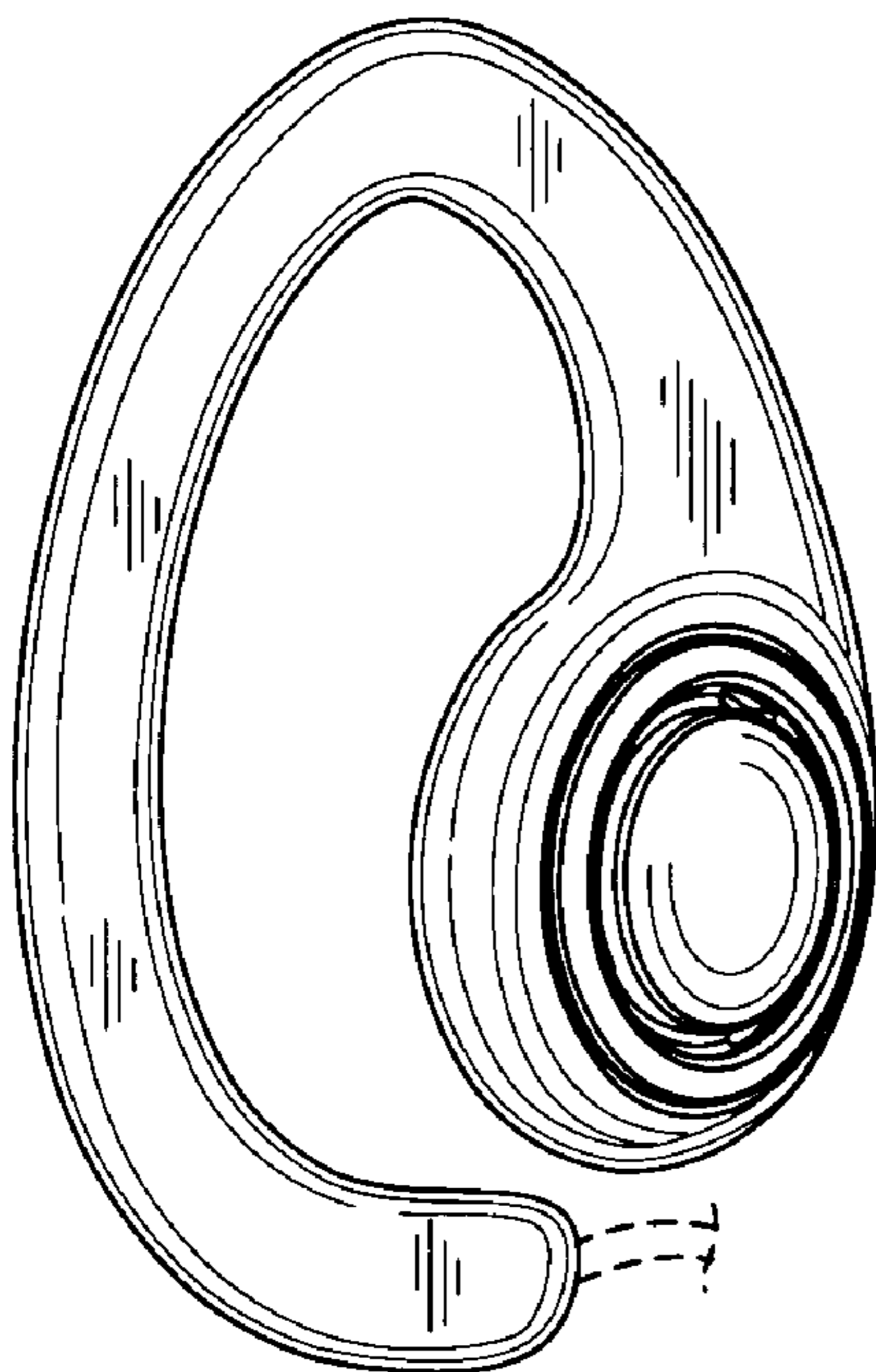
FIG. 5 is a top elevational view thereof;

FIG. 6 is a bottom elevational view thereof; and,

FIG. 7 is a back elevation view thereof.

The broken lines showing recesses, vents, ports and a cable extending therefrom are for illustrative purpose only and form no part of the claimed design.

1 Claim, 1 Drawing Sheet



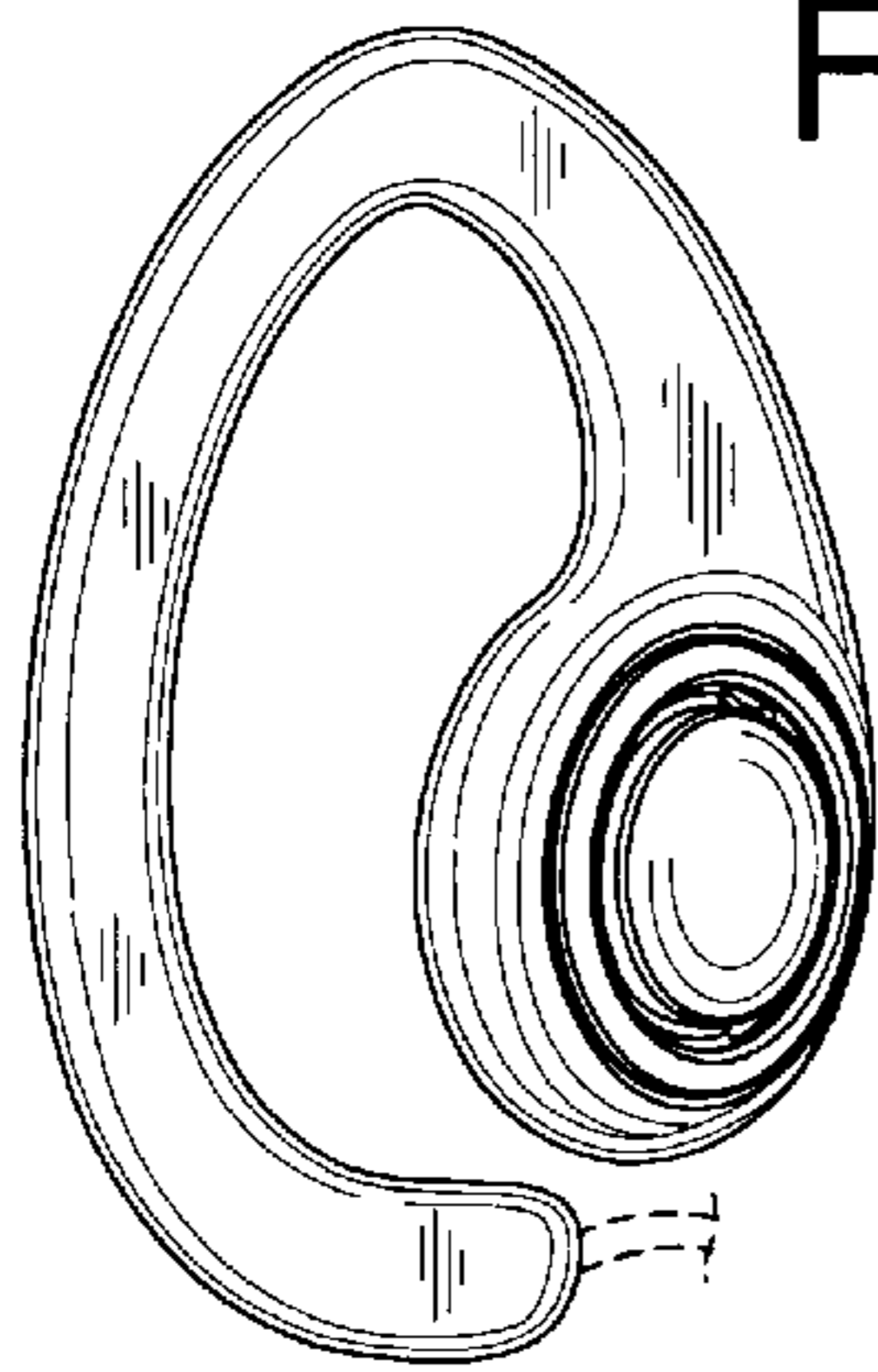


FIG. 1A

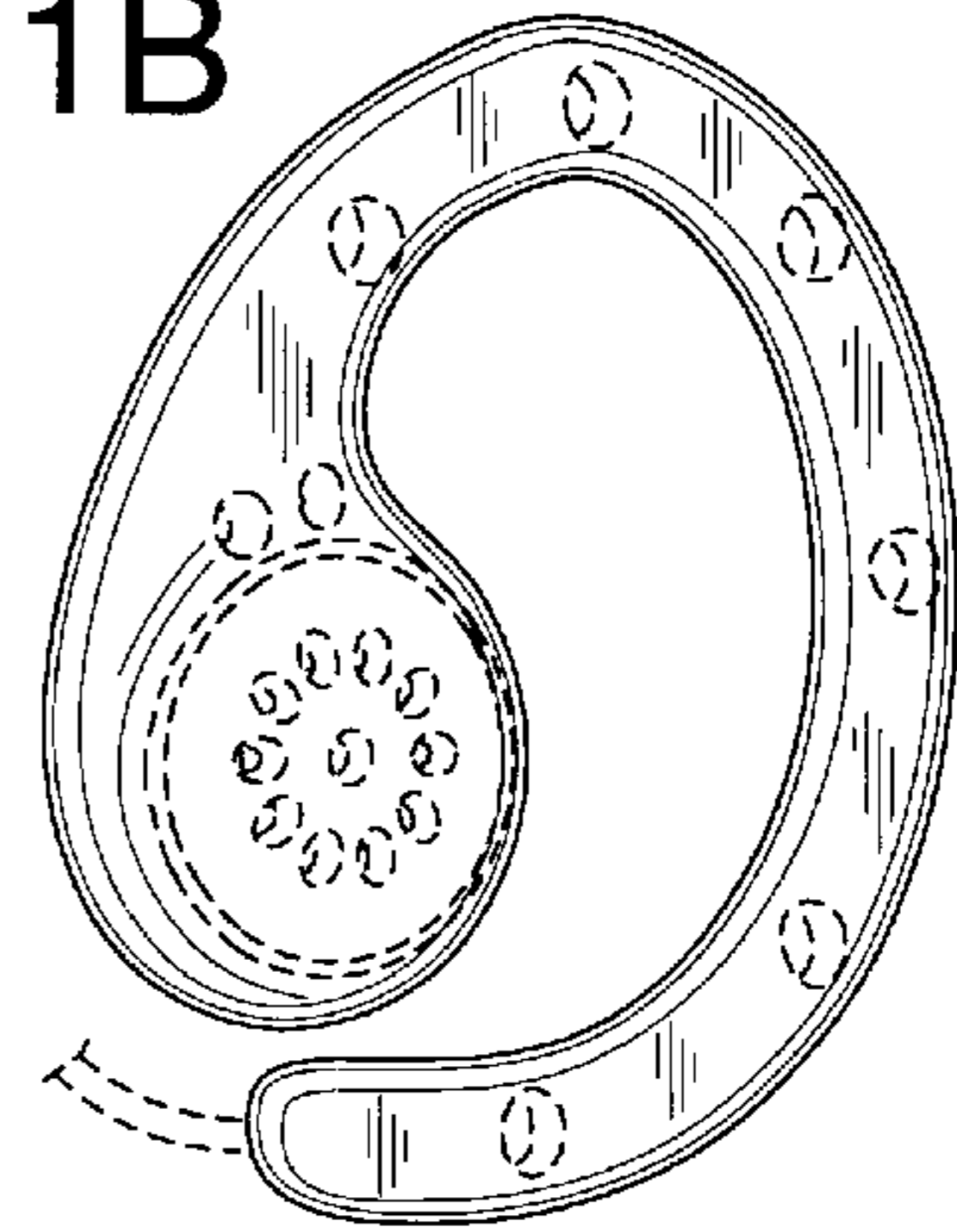


FIG. 1B

FIG. 5

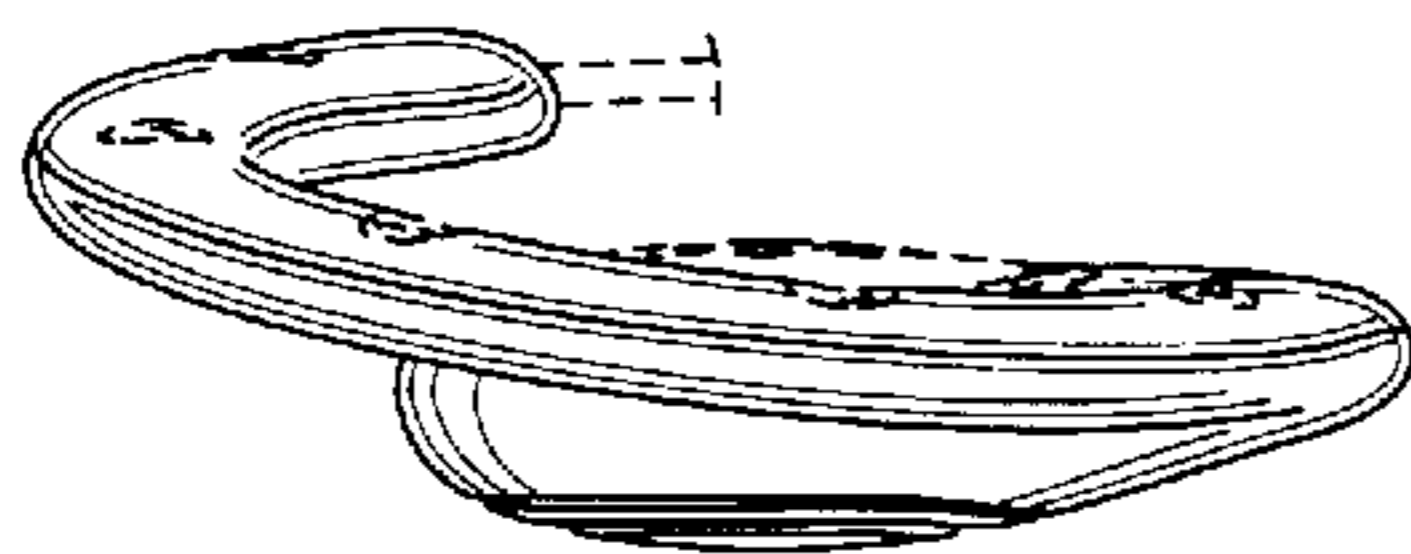


FIG. 3

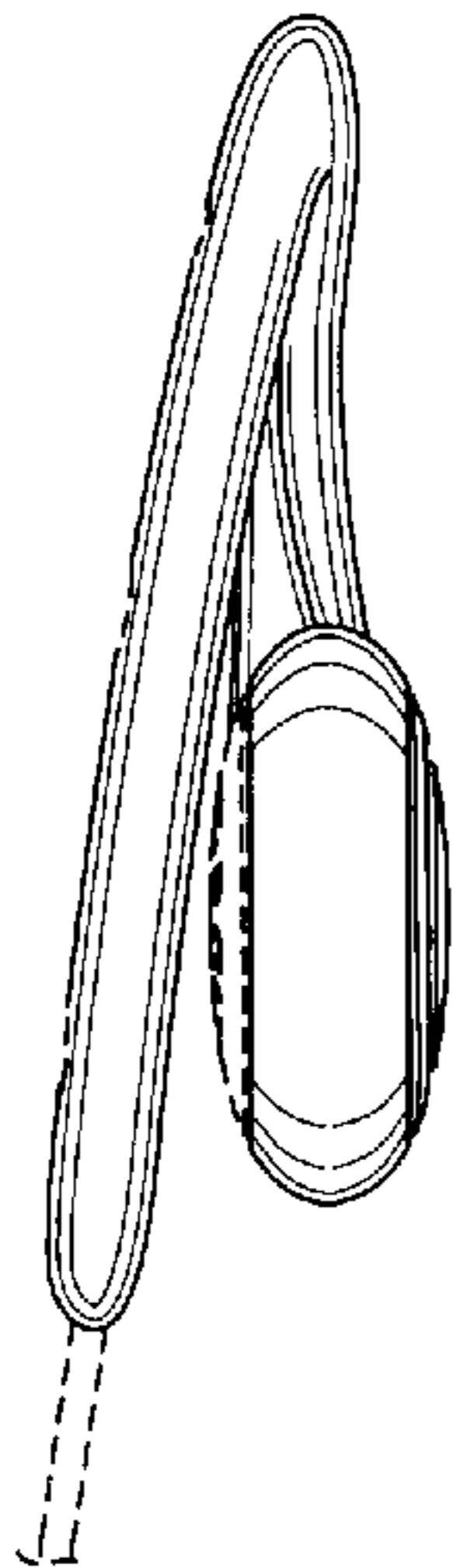


FIG. 2

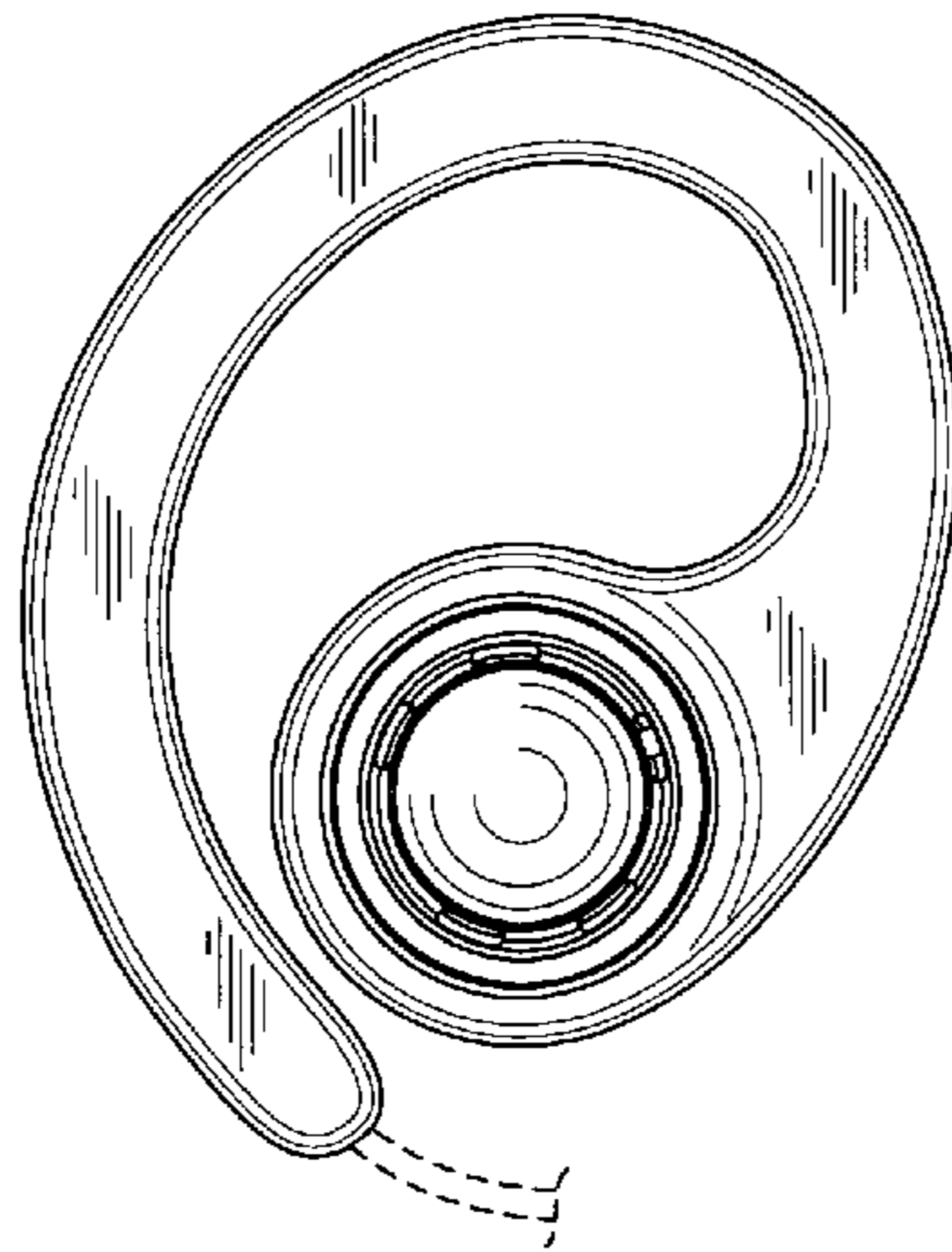


FIG. 4

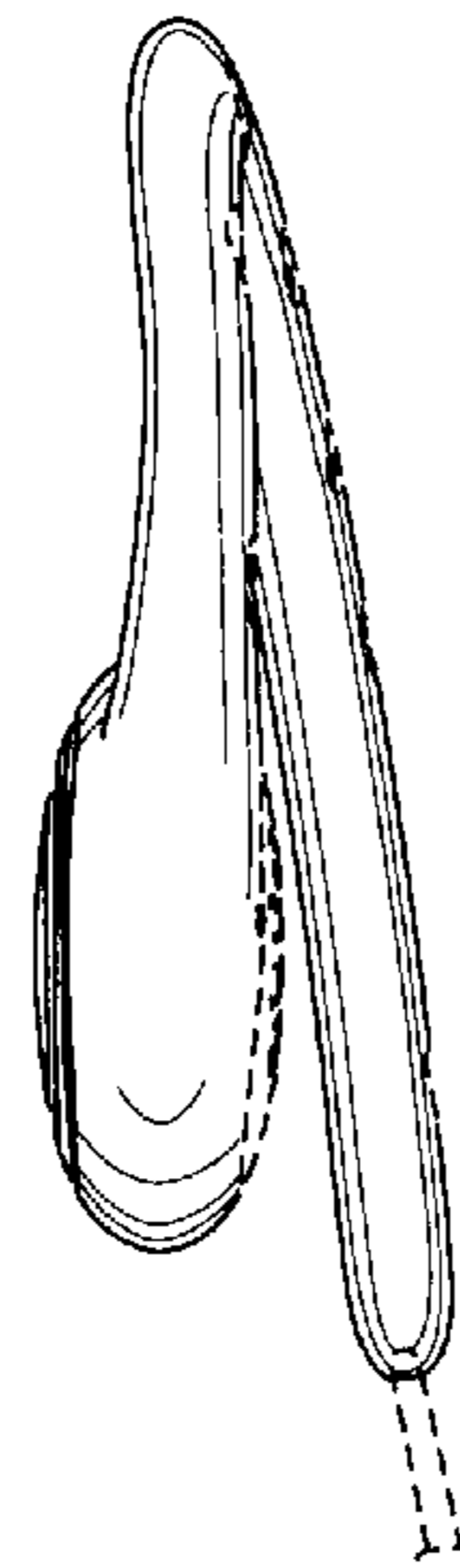


FIG. 7

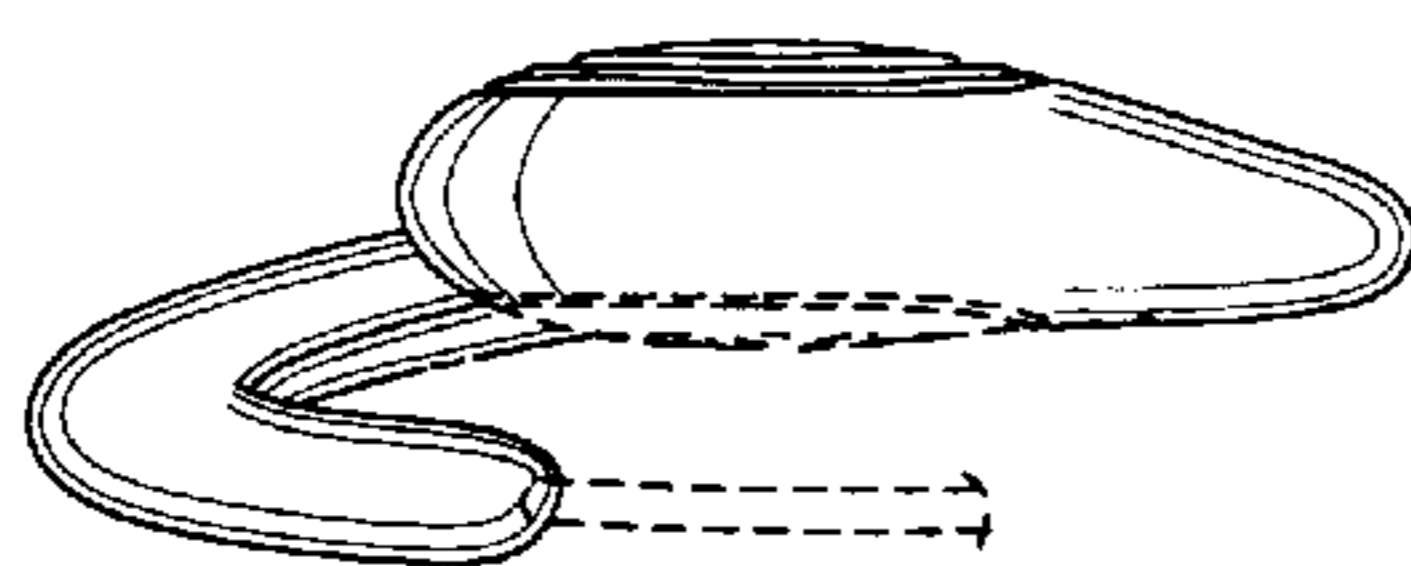
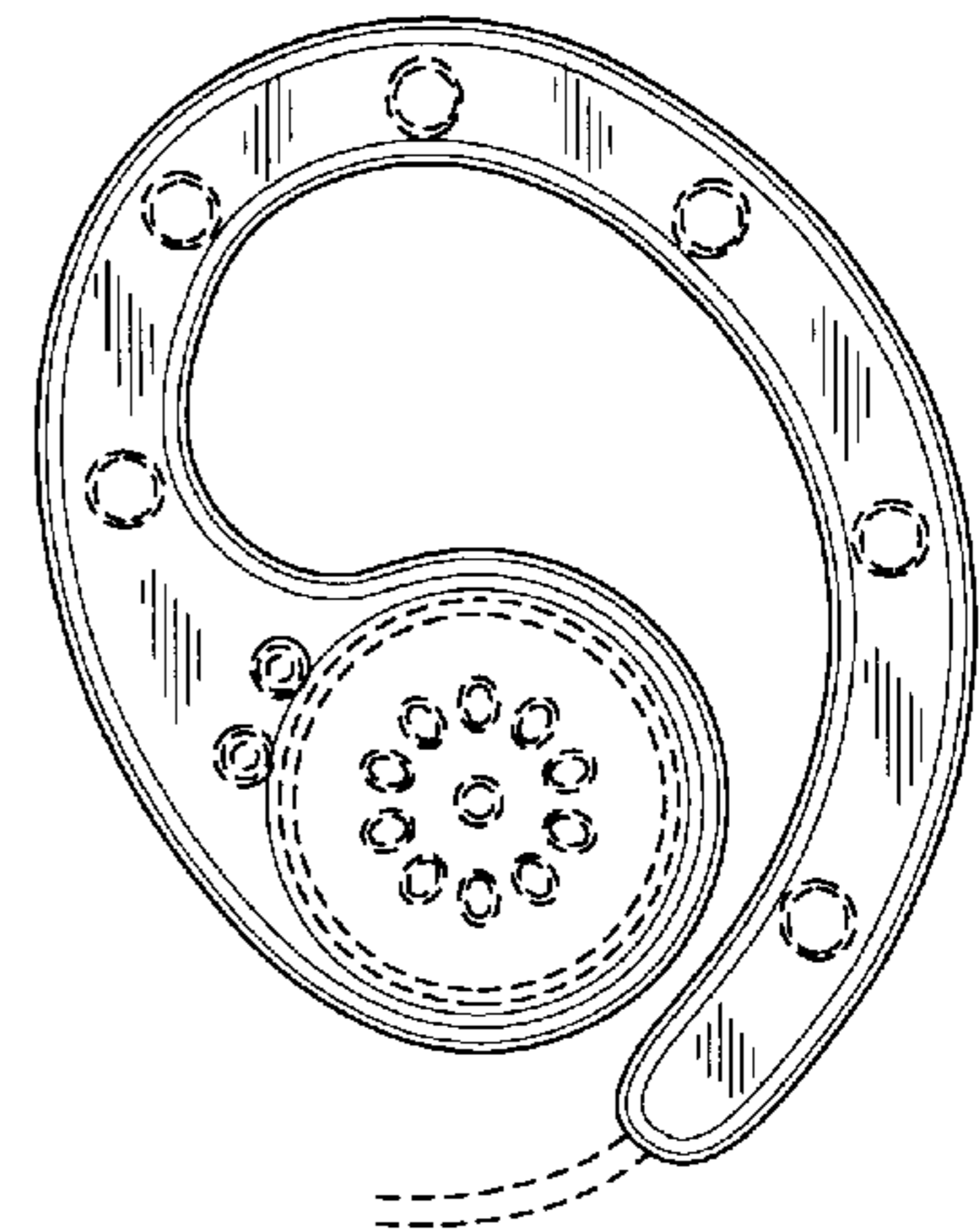


FIG. 6